Technical Description:

The Equipment Under Test (EUT) is a 2.4GHz Bluetooth speaker. The Bluetooth portion is operating between 2402MHz and 2480MHz (79 channels with 1MHz channel spacing). The EUT is powered by 120VAC. When the EUT is switched ON, the light will be flashing. The corresponding Bluetooth device would be searched and connected to the EUT before playing audio. After pairing, the light will stay lit.

2.4GHz Bluetooth Module:

Modulation Type: GFSK

Frequency Range: 2402MHz - 2480MHz, 1MHz channel spacing, 79 channels

Antenna Type: Integral, Internal (PCB Trace)

Antenna Gain: 0dBi

Nominal rated field strength: 104.1dBµV/m at 3m

Maximum allowed field strength of production tolerance: +0.5dB / - 3dB

1. Bluetooth module F-3098:

- a. BC6145 (U1) acts as the radio core of Bluetooth module.
- b. The 26MHz crystal (XT1) provides system clock for BC6145 (U1).

2. Audio:

a. HT6873 (U3) is power amplifier driving a speaker.

3. Power Management portion:

a. HT7533 (U1) is 3.3V regulator which is providing 3.3V to Bluetooth module.

F-3098 Module Specification

Module description

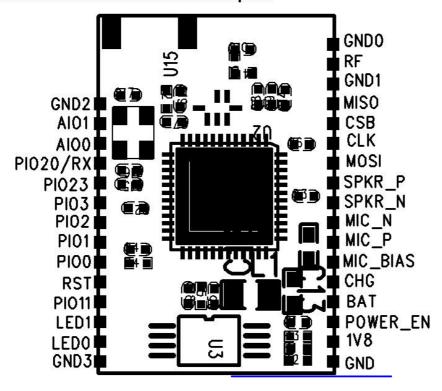
significantly

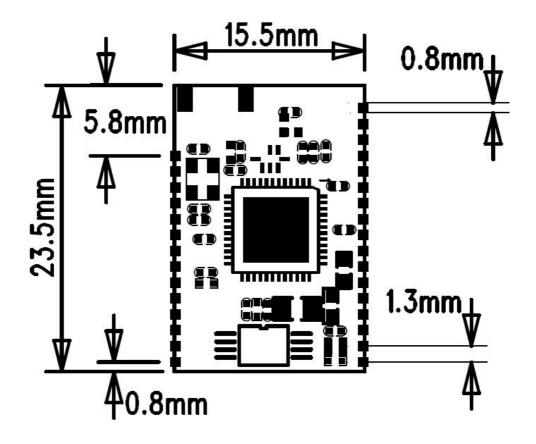
- ●Using the latest CSR BC6 chip, the quality and the overall RF performance improved
- •in accordance with Bluetooth V3.0
- •Bluetooth headsets, speakers, car low cost solution
- support with connected with two mobile phone
- •support HSP V1.2, HFP V1.5
- high quality audio processing A2DP V1.2
- ●It is up to the 8.5dB transmit power, receive sensitivity: 91dB
- module size: L23.5 x W15.5 x H1.8 mm

Application:

- High quality Bluetooth headset
- The Bluetooth hands-free,
- The Bluetooth hands-free,

The size of the module and foot bitmap:





性能参数:

型 号	F-3098	
蓝牙规格	Bluetooth V3.0	
调制方式	GFSK, 1Mbps, 0.5BT Gaussian	
供电电压:	Battery voltage VDD:3.3 supply	
支持蓝牙协义	A2DP, HSP, HFP	
工作电流	≤30mA	
待机电流	<0.4mA	
温度范围	-40°C to +80°C	
无线传输范围:	10米	
传输功率:	CLASS 2 4dBm	
灵敏度:	-91dBm@0.1%BER	
频率范围:	2. 4GHz-2. 480GHz	
对外接口:	PIO, SPI, Speake, Microphone	
音频性能	High acoustic fidelity sound	
音频信噪比:	≥75dB	
失真度	€0.01%	
模块尺寸	23.5X15.5X1.8MM	

公司: 深圳芯中芯科技有限公司

电话: 0755-29179480/1/2, FAX: 0755-84736169 2

Pin description:

1、Pin			
Configurations	NAME	ТҮРЕ	FUNCTION
PIN NO.	GND2	GND	Ground connections
1	AIO1	Bidirectional	Programmable input/output line
2	AIO1	Bidirectional	Programmable input/output line
3			
4	PIO20/RX	Bidirectional with weak	UART data input, active high. PIO[20] is
		internal pull-down	clock for SPI flash interface
5	PIO23/TX	Bidirectional with weak	UART data output, active high. PIO[23] is
		internal pull-up	data output for SPI flash interface
6	PIO3	Bidirectional with	Programmable input/output line
		programmable strength	PIO[3] is chip select for SPI flash
		internal pull-up/down	interface
7	PIO2	Bidirectional with	Programmable input/output line
		programmable strength	
		internal pull-up/down	
8	PIO1	Bidirectional with	Programmable input/output line
		programmable strength	
		internal pull-up/down	
9	PIO0	Bidirectional with	Programmable input/output line
		programmable strength	
		internal pull-up/down	
10	RST	Input with weak internal	Reset if low. Input debounced so
		pull-up	must be low for >5ms to cause a
			reset
11	PIO11	Bidirectional with	Programmable input/output line.
		programmable strength	PIO[11] is data input for SPI flash
		internal pull-up/down	interface
12	LED1	Open drain output	LED driver
13	LED0	Open drain output	LED driver
14	GND3	GND	Gronnd connections
15	GND	GND	Gronnd connections
16	1V8	Power	Positive supply for bluecore
17	POWER_EN		Take high to enable both high-voltage
45			regulator and switch-mode regulator
18	BAT		Lithium ion/polymer battery positive
			teminal.Battery charger output and
			input to switch-mode regulator
19	СНС		Lithium ion/polymer battery charger

input
20 MIC_BIAS Analogue Microphone bias

	1	1	
21	MIC_P	Analogue	Microphone input, positive
22	MIC_N	Analogue	Microphone input, negative
23	SPKR_N	Analogue	Speaker output, negative
24	SPKR_P	Analogue	Speaker output, positive
25	MOSI	with weak internal	SPI data input
		pull-down	
26	CLK	Bidirectional with weak	SPI clock
		internal pull-down	
27	CSB	Bidirectional with weak	Chip select for SPI, active low
		internal pull-down	
28	MISO	Bidirectional with weak	SPI data output
		internal pull-down	
29	GND1	GND	Gronnd connections
30	RF	RF	RF
31	GND0	GND	GND

Matters needing attention:

- 1.The antenna side not of metal
- 2 .box can not be large shield
- 3 .should be placed near the electrolytic capacitor in the PAD modules.
- 4. The common end of noise inhibition, the need to increase the operational amplifier in front amplifier or master to eliminate interference
- 5. main control, power amplifier, the module must be well grounded, don't allow the island or closed loop, module grounding

And the main control and power amplifier ground potential difference between shall not be greater than 1mV.

The application circuit diagram:

